

### GENERAL DESCRIPTION

The SGM05FB1E2 is a femto-farad capacitance ESD protection device. As a new generation TVS, it is applied to protect circuits from electrostatic discharge.

### FEATURES

- High ESD Withstand Voltage:
  - ◆ IEC 61000-4-2: ±12kV (Air)
  - ◆ IEC 61000-4-2: ±12kV (Contact)
- Low Profile Packages: XTDFN-0.6×0.3-2L and UTDFN-1×0.6-2L
- Working Voltage: 5V and Below
- Rated Peak Pulse Current: 2.4A
- Low Channel Input Capacitance: 0.3pF (TYP)

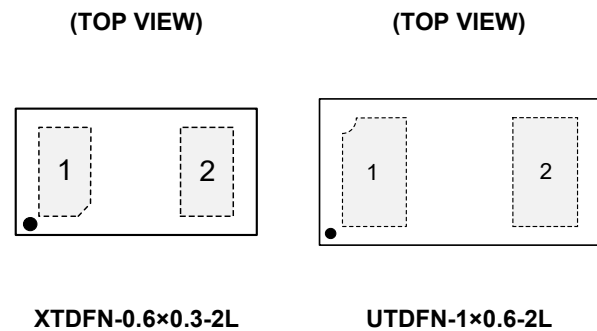
### APPLICATIONS

Thunderbolt  
HDMI  
USB3.0  
DisplayPort Interface  
IEEE 1394  
10/100Mbit/s Ethernet  
Desktop and Notebooks

### PRODUCT SUMMARY

$V_{RWM}$ (TYP)	$I_{PP}$ (TYP)	$C_{IN}$ (TYP)
5V	2.4A	0.3pF

### PIN CONFIGURATIONS



### EQUIVALENT CIRCUIT



### ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	VALUE	UNITS
Peak Pulse Current ( $t_p = 8/20\mu s$ )	$I_{PPM}$	2.4	A
ESD IEC 61000-4-2 (Air)	$V_{ESD}$	±12	kV
ESD IEC 61000-4-2 (Contact)		±12	
Operating Temperature Range	$T_{OP}$	-40 to +125	°C
Storage Temperature Range	$T_{STG}$	-55 to +150	°C
Lead Temperature (Soldering, 10s)		+260	°C

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

## SGM05FB1E2

### PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
SGM05FB1E2	XTDFN-0.6×0.3-2L	-40°C to +125°C	SGM05FB1E2XXEI2G/TR	3I	Tape and Reel, 10000
	UTDFN-1×0.6-2L	-40°C to +125°C	SGM05FB1E2XUEG2G/TR	X9X	Tape and Reel, 10000

### MARKING INFORMATION

NOTE: Fixed character for 3I.

**XTDFN-0.6×0.3-2L**

**YY**

Serial Number

NOTE: X = Date Code.

**UTDFN-1×0.6-2L**

**YY X**

Date Code - Quarter  
Serial Number

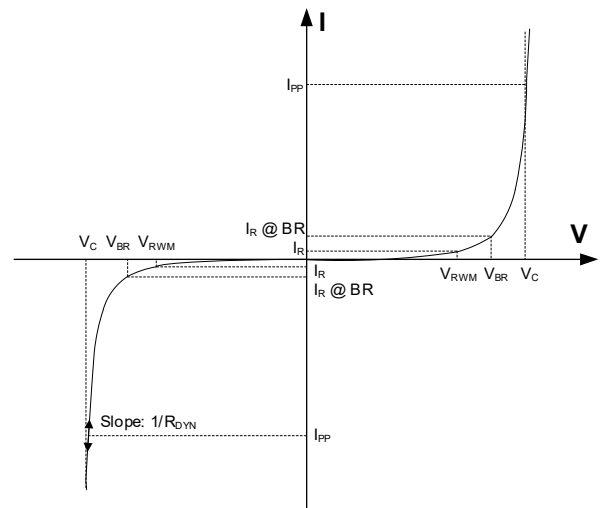
Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

### DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

### ELECTRICAL PARAMETERS

SYMBOL	PARAMETER
$V_{RWM}$	Reverse Stand-Off Voltage
$V_{BR}$	Reverse Breakdown Voltage
$I_R$	Reverse Leakage Current
$I_R @ BR$	Reverse Leakage Current @ Breakdown
$V_C$	Clamping Voltage @ $I_{PP}$
$I_{PP}$	Peak Pulse Current
$R_{DYN}$	Dynamic Resistance



**ELECTRICAL CHARACTERISTICS**

(T<sub>A</sub> = +25°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Reverse Stand-Off Voltage	V <sub>RWM</sub>				5	V
Reverse Breakdown Voltage	V <sub>BR</sub>	I <sub>R</sub> = 1mA	6	7.2	8.5	V
Reverse Leakage Current	I <sub>R</sub>	V <sub>RWM</sub> = 5V			600	nA
Channel Input Capacitance	C <sub>IN</sub>	V <sub>R</sub> = 0V, f = 1MHz, I/O to GND		0.3	0.35	pF
Surge Clamping Voltage <sup>(1)</sup>	V <sub>C-Surge</sub>	I <sub>PPM</sub> = 2.4A		11.4		V
ESD Clamping Voltage <sup>(2)</sup>	V <sub>C</sub>	I <sub>TLP</sub> = 8A (Equivalent IEC61000-4-2 Contact +4kV)		16.6		V
		I <sub>TLP</sub> = 16A (Equivalent IEC61000-4-2 Contact +8kV)		24.2		V
Dynamic Resistance <sup>(2)</sup>	R <sub>DYN</sub>	t <sub>p</sub> = 100ns		0.95		Ω

NOTE:

1. Non-repetitive current pulse 8/20μs exponential decay waveform according to IEC 61000-4-5, 2Ω source impedance.
2. Non-repetitive current pulse. Transmission line pulse (TLP) t<sub>p</sub> = 100ns, square pulse.

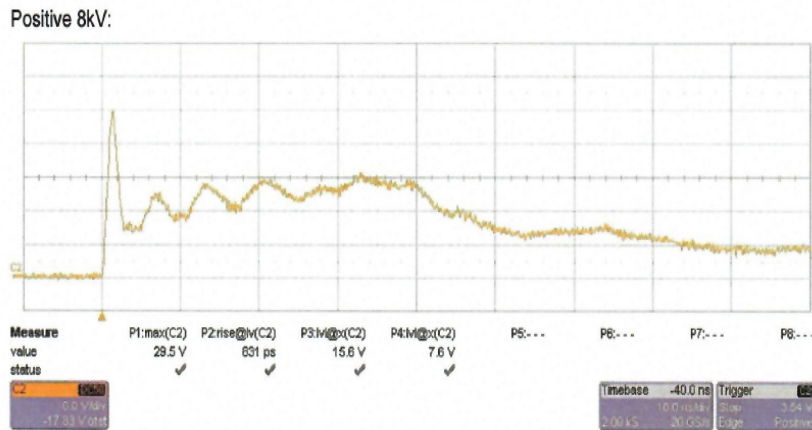


Figure 1. Typical Pulses ESD 8kV Contact per IEC 61000-4-2

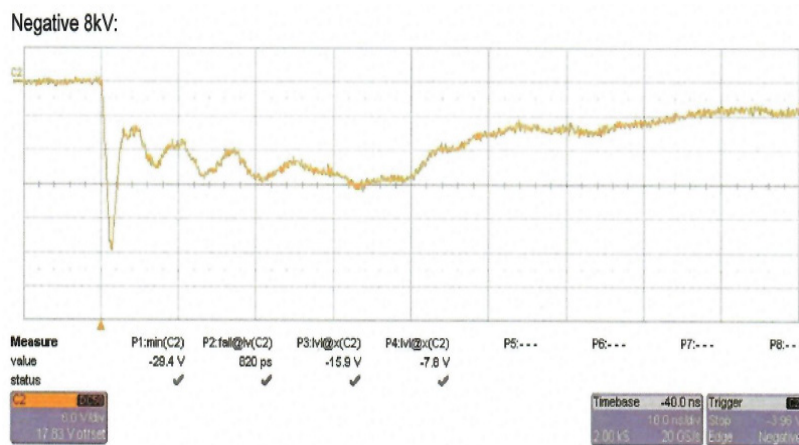
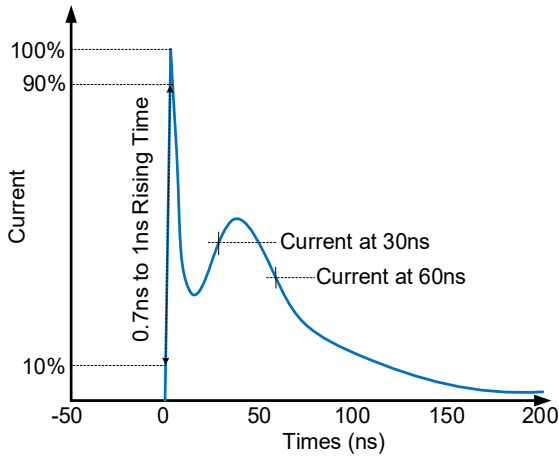


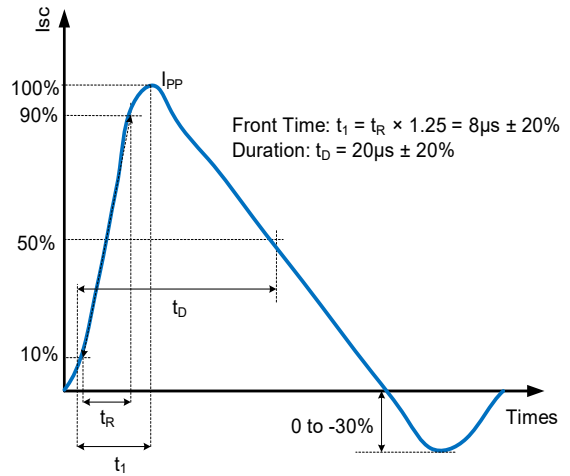
Figure 2. Typical Pulses ESD -8kV Contact per IEC 61000-4-2

TYPICAL PERFORMANCE CHARACTERISTICS

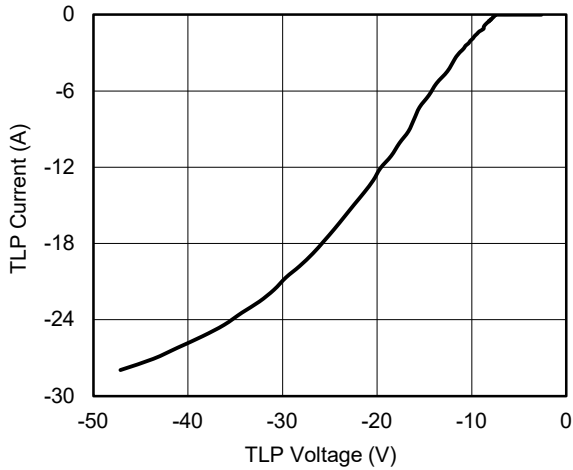
ESD Pulse Waveform per IEC 61000-4-2



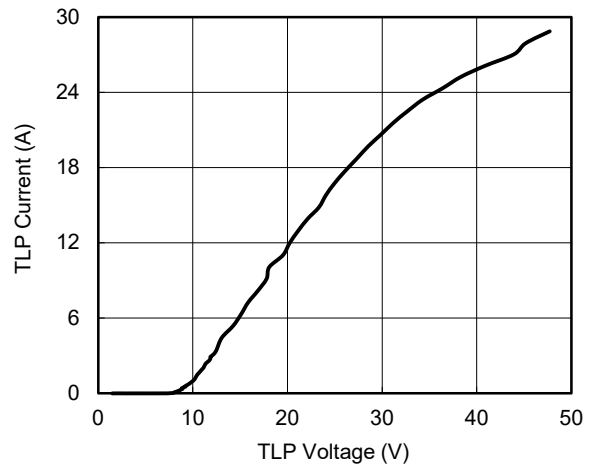
8/20µs Waveform per IEC 61000-4-5



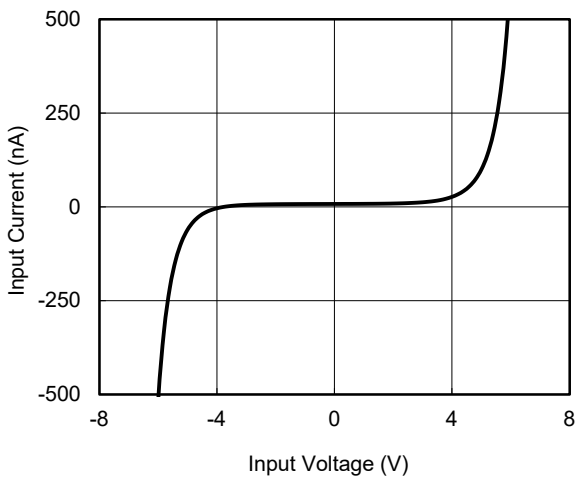
TLP\_Pin1(-) to Pin2(+)



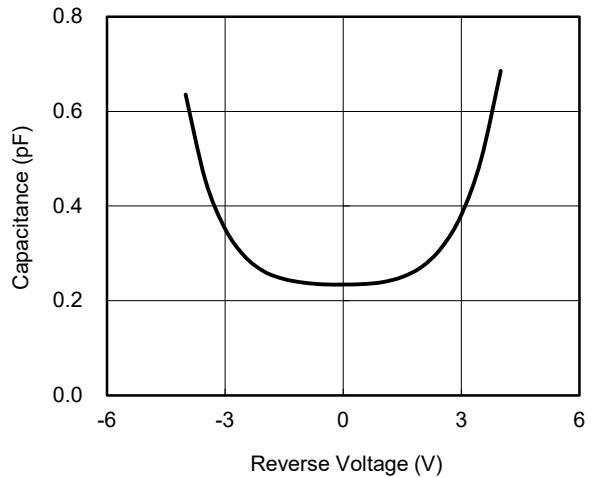
TLP\_Pin1(+) to Pin2(-)



IV Curve

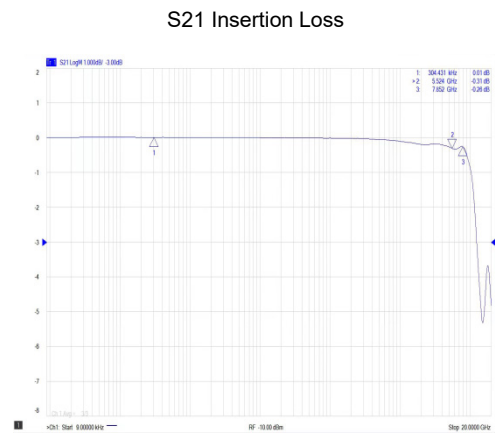
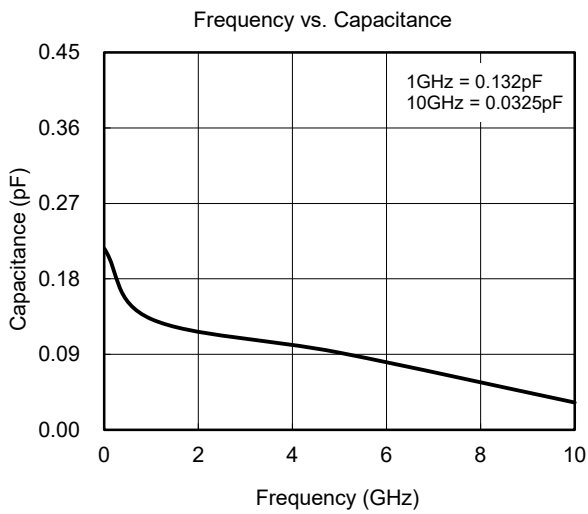


Capacitance vs. Reverse voltage

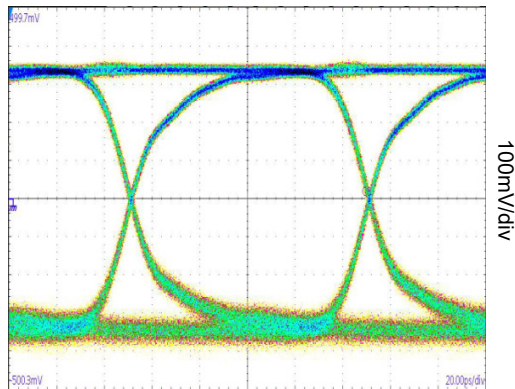


## SGM05FB1E2

### TYPICAL PERFORMANCE CHARACTERISTICS (continued)

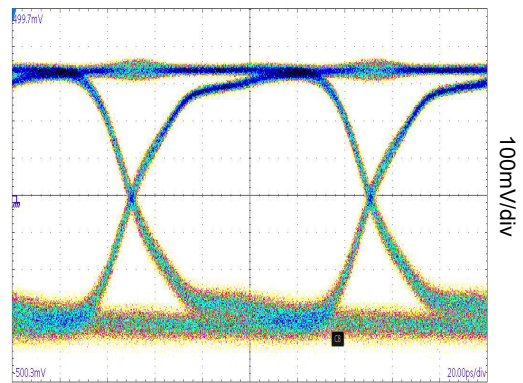


USB3.x Eye Diagram without SGM05FB1E2  
10Gbps, 800mV<sub>PP</sub>, Test Board Only



Time (20ps/div)

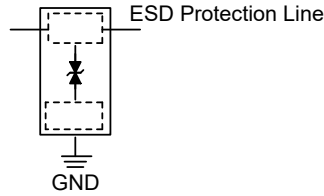
USB3.x Eye Diagram with SGM05FB1E2  
10Gbps, 800mV<sub>PP</sub>, Test Board + SGM05FB1E2



Time (20ps/div)

**APPLICATION INFORMATION**

The SGM05FB1E2 is applied to offer a bidirectional line in order to eliminate ESD events on high-speed signals. The device is a good choice for lines with positive and negative signal polarity relative to the ground.



**Figure 3. Application Diagram**

The recommended guidelines are as follows:

**1. TVS Placement**

Place the TVS as close as possible to the input connector.

**2. TVS's Trace Layout**

Avoid running protected traces in parallel with unprotected traces.

Minimize the path length between the TVS and the protected line.

Minimize parallel signal path length.

Route the protected traces as straight as possible.

**3. GND Layout**

Avoid using a common ground point shared with the TVS transient return path.

Minimize the length of the TVS transient return path to ground.

Use ground vias as close as possible to the TVS transient return to ground.

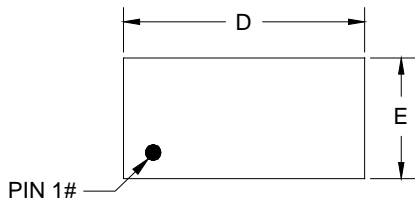
**REVISION HISTORY**

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

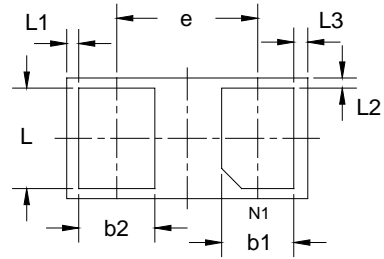
NOVEMBER 2025 – REV.A to REV.A.1	Page
Updated typical performance characteristics.....	5
Changes from Original (DECEMBER 2023) to REV.A	Page
Changed from product preview to production data.....	All

PACKAGE OUTLINE DIMENSIONS

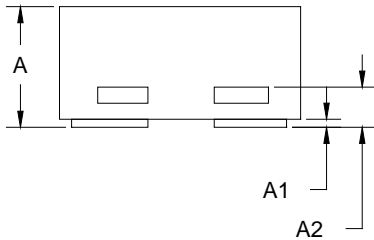
XTDFN-0.6x0.3-2L



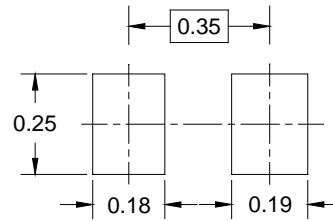
TOP VIEW



BOTTOM VIEW



SIDE VIEW



RECOMMENDED LAND PATTERN (Unit: mm)

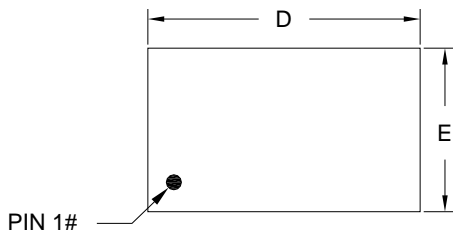
Symbol	Dimensions In Millimeters		
	MIN	MOD	MAX
A	0.280	0.300	0.320
A1	0.000	0.020	0.050
A2	0.050	0.100	0.150
b1	0.130	0.180	0.230
b2	0.140	0.190	0.240
D	0.550	0.600	0.650
E	0.250	0.300	0.350
e	0.350 BSC		
L	0.200	0.250	0.300
L1	0.030 BSC		
L2	0.025 BSC		
L3	0.035 BSC		

NOTE: This drawing is subject to change without notice.

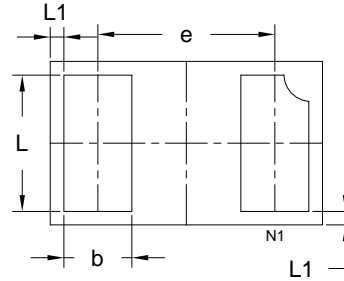
# PACKAGE INFORMATION

## PACKAGE OUTLINE DIMENSIONS

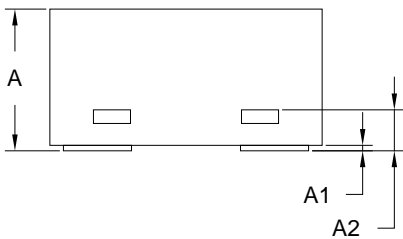
### UTDFN-1x0.6-2L



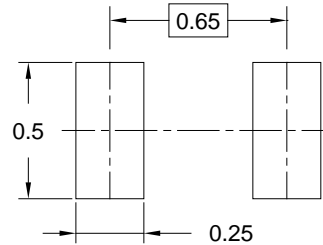
**TOP VIEW**



**BOTTOM VIEW**



**SIDE VIEW**



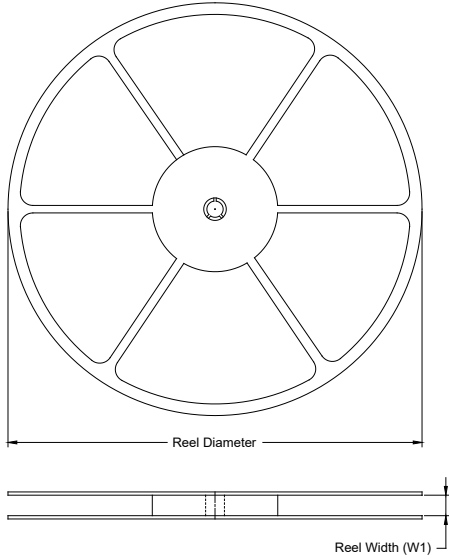
**RECOMMENDED LAND PATTERN (Unit: mm)**

Symbol	Dimensions In Millimeters		
	MIN	MOD	MAX
A	0.450	0.500	0.550
A1	0.000	-	0.050
A2	0.120	0.150	0.180
b	0.200	0.250	0.300
D	0.950	1.000	1.050
E	0.550	0.600	0.650
e	0.650 BSC		
L	0.450	0.500	0.550
L1	0.050 REF		

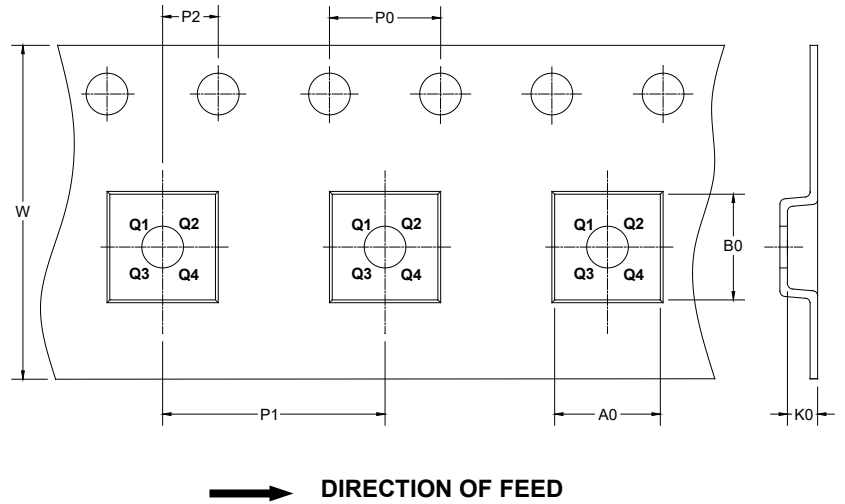
NOTE: This drawing is subject to change without notice.

TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

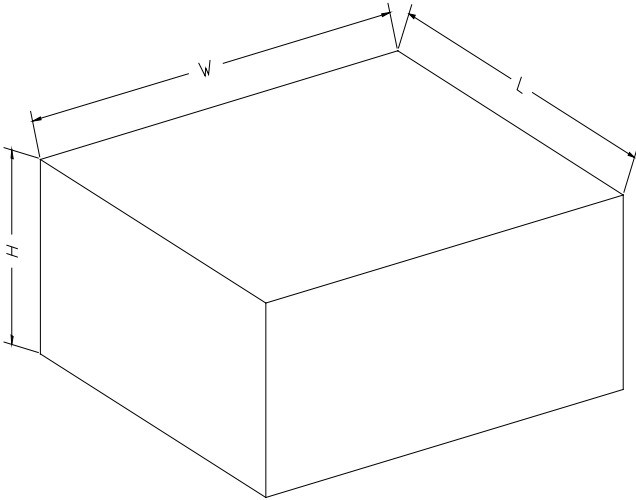
KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
XTDFN-0.6×0.3-2L	7"	8.6	0.37	0.67	0.34	4.0	2.0	2.0	8.0	Q1
UTDFN-1×0.6-2L	7"	8.6	0.70	1.15	0.57	4.0	2.0	2.0	8.0	Q1

DD0001

# PACKAGE INFORMATION

## CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

## KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
7" (Option)	368	227	224	8
7"	442	410	224	18

DP0002